

A

B

C

D

E

CUSTOMER DRAWING

REVISIONS			
SYM	ECN No.	DESCRIPTION	DATE
A01		MASS PRODUCTION	09/29/04
			APPROVED Jenny Chung

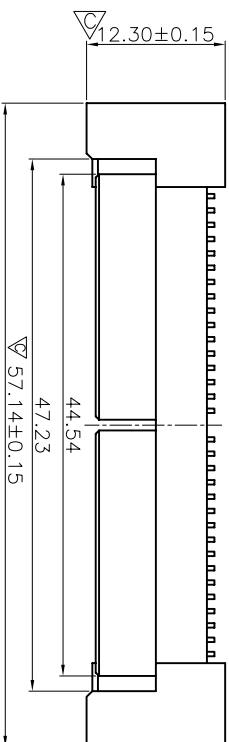


TABLE2

3.18±0.1	4.8±0.2
1.57±0.1	3.2±0.2
PCB THICKNESS	PEG LENGTH

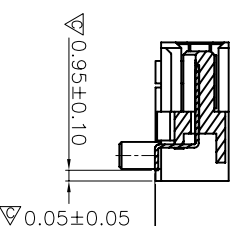
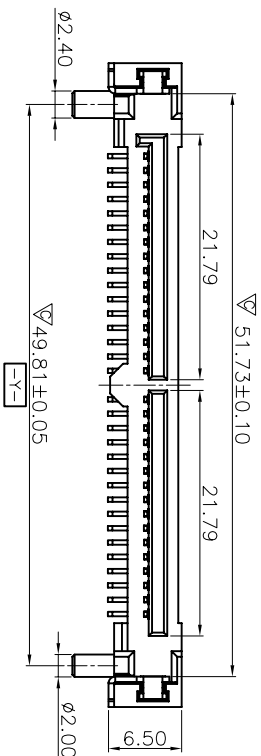
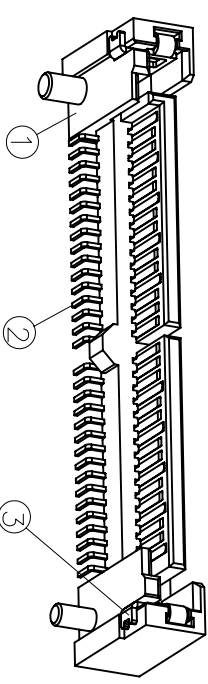
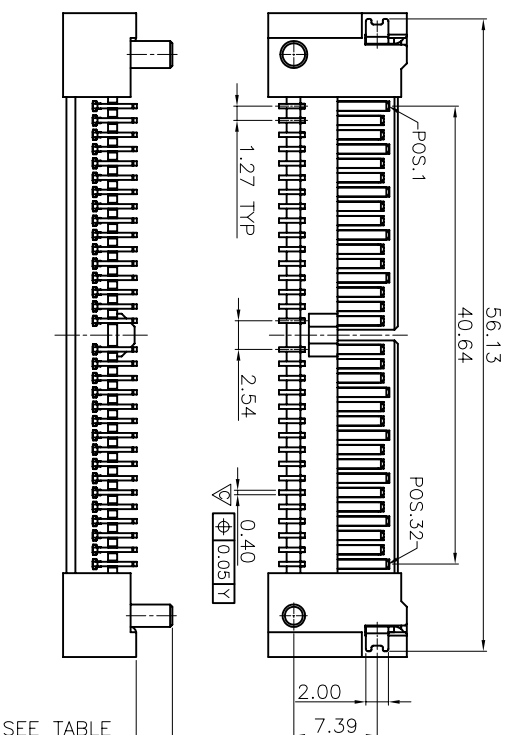
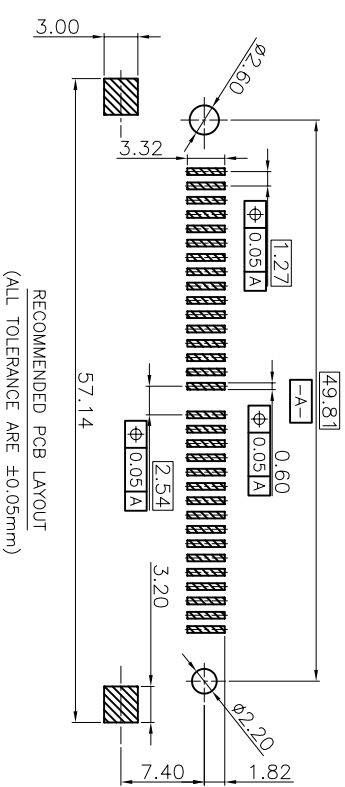


TABLE1

3	BOARD LOCK	2	COPPER ALLOY	NI UNDERPLATING TIN PLATED ON SOLDER AREA
2	CONTACT	32	COPPER ALLOY	NI UNDERPLATING TIN PLATED ON SOLDER AREA GOLD PLATING ON CONTACT AREA
1	BASE	1	THERMAL PLASTIC	COLOR:BLACK
ITEM	DESCRIPTION	Q'TY	MATERIAL	FINISH



SEE TABLE

RECOMMENDED PCB LAYOUT
(ALL TOLERANCE ARE ±0.05mm)

NOTES:

1. MATERIAL: SEE TABLE 1.
2. FINISH:
15u" GOLD PLATING ON CONTACT AREAS;
100u" TIN (LEAD-FREE) PLATED ON SOLDER TAILS;
50u" NICKEL UNDERPLATE OVER ALL.
3. THE MARK ∇ DIMENSIONS MUST BE CONTROLLED BY QC.
4. PRODUCT SPECIFICATION REFERENCE TO *****.
5. PACKAGING SPECIFICATION REFERENCE TO *****.

APPROVALS		DATE	TC&C Electronics Co.,Ltd				
DRAWN	JENNY CHUNG	09/29'06					
CHECKED	JENNY CHUNG	09/29'06					
APPROVED							
TITLE SAS 32P R/A SMT TYPE, FOR PCB MOUNT			SCALE N.A.		PART NO.	DRAWING NO.	REV.
			SHEET 1 OF 1		T5049B32BA22TN0	T5049B32BA22TN0	A01
			CUSTOMER PART NO.				
	UNIT	MM					